

SN65LBC174A, SN75LBC174A QUADRUPLE RS-485 DIFFERENTIAL LINE DRIVERS

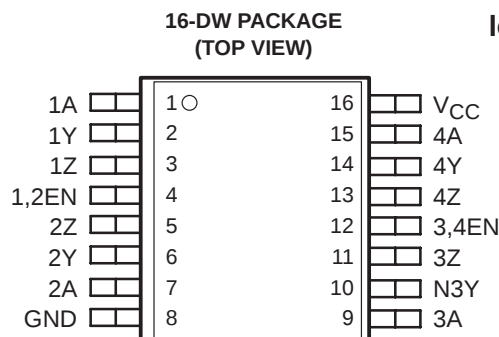
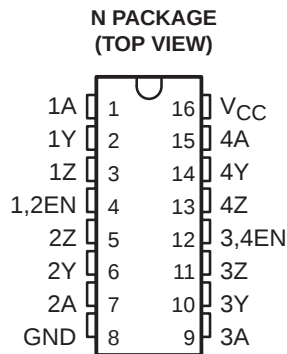
SLLS446C – OCTOBER 2000 – REVISED MAY 2003

- Designed for TIA/EIA-485, TIA/EIA-422 and ISO 8482 Applications
- Signaling Rates[†] up to 30 Mbps
- Propagation Delay Times < 11 ns
- Low Standby Power Consumption
1.5 mA Max
- Output ESD Protection Exceeds 13 kV
- Driver Positive- and Negative-Current Limiting
- Power-Up and Power-Down Glitch-Free for Line Insertion Applications
- Thermal Shutdown Protection
- Industry Standard Pin-Out, Compatible With SN75174, MC3487, DS96174, LTC487, and MAX3042

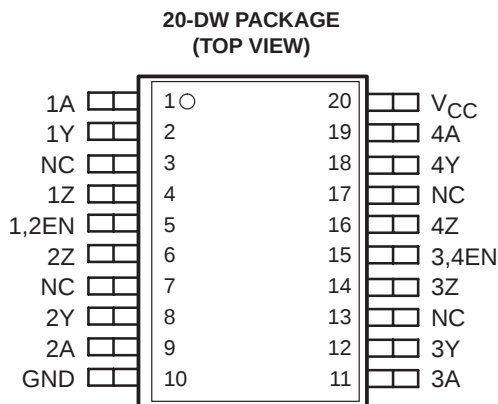
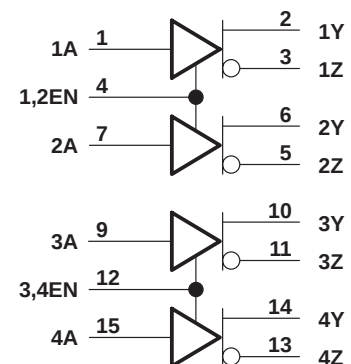
description

The SN65LBC174A and SN75LBC174A are quadruple differential line drivers with 3-state outputs, designed for TIA/EIA-485 (RS-485), TIA/EIA-422 (RS-422), and ISO 8482 applications.

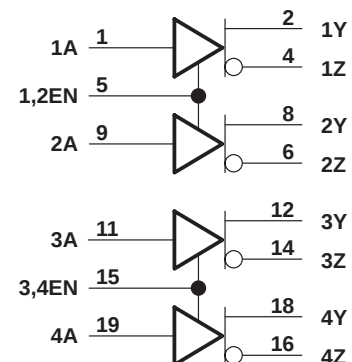
These devices are optimized for balanced multipoint bus transmission at signalling rates up to 30 million bits per second. The transmission media may be printed-circuit board traces, backplanes, or cables. The ultimate rate and distance of data transfer is dependent upon the attenuation characteristics of the media and the noise coupling to the environment.



logic diagram (positive logic)



logic diagram (positive logic)



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

[†]The signaling rate of a line is the number of voltage transitions that are made per second expressed in the units bps (bits per second).

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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SN65LBC174A, SN75LBC174A QUADRUPLE RS-485 DIFFERENTIAL LINE DRIVERS

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description (continued)

Each driver features current limiting and thermal-shutdown circuitry making it suitable for high-speed multipoint applications in noisy environments. These devices are designed using LinBiCMOS™, facilitating low power consumption and robustness.

The two EN inputs provide pair-wise driver enabling, or can be externally tied together to provide enable control of all four drivers with one signal. When disabled or powered off, the driver outputs present a high-impedance to the bus for reduced system loading.

The SN75LBC174A is characterized for operation over the temperature range of 0°C to 70°C. The SN65LBC174A is characterized for operation over the temperature range of –40°C to 85°C.

AVAILABLE OPTIONS

T _A	PACKAGE		
	16-PIN PLASTIC SMALL OUTLINE† (JEDEC MS-013)	20-PIN PLASTIC SMALL OUTLINE† (JEDEC MS-013)	16-PIN PLASTIC THROUGH-HOLE (JEDEC MS-001)
0°C to 70°C	SN75LBC174A16DW	SN75LBC174ADW	SN75LBC174AN
	Marked as 75LBC174A		
–40°C to 85°C	SN65LBC174A16DW	SN65LBC174ADW	SN65LBC174AN
	Marked as 65LBC174A		

† Add R suffix for taped and reeled version.

FUNCTION TABLE (EACH DRIVER)

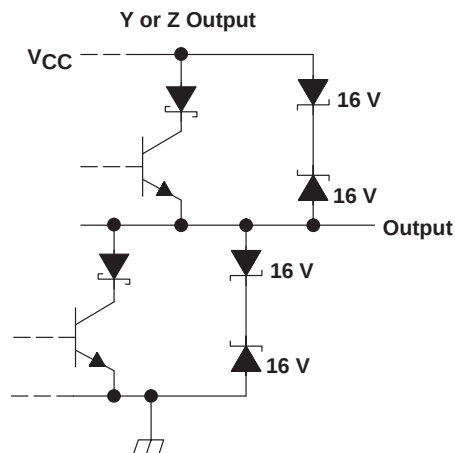
INPUT	ENABLE	OUTPUTS	
A	G	Y	Z
L	H	L	H
H	H	H	L
OPEN	H	H	L
L	OPEN	L	H
H	OPEN	H	L
OPEN	OPEN	H	L
X	L	Z	Z

H = high level, L = low level, X = irrelevant,
Z = high impedance (off)

LinBiCMOS is a trademark of Texas Instruments.



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Supply voltage range, V_{CC} (see Note 1)		-0.3 V to 6 V
Voltage range at any bus (DC)		-10 V to 15 V
Voltage range at any bus (transient pulse through 100 Ω , see Figure 8)		-30 V to 30 V
Input voltage range at any A or EN terminal, V_I		-0.5 V to $V_{CC} + 0.5$ V
Electrostatic discharge: Human body model (see Note 2)	Y, Z, and GND	13 kV
	All pins	5 kV
	Charged-device model (see Note 3) All pins	1 kV
Storage temperature range, T_{stg}		-65°C to 150°C
Continuous power dissipation		See Dissipation Rating Table
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds		260°C

NOTES:

1. All voltage values, except differential I/O bus voltages, are with respect to GND.
2. Tested in accordance with JEDEC standard 22, Test Method A114-A.
3. Tested in accordance with JEDEC standard 22, Test Method C101.

PACKAGE	JEDEC BOARD MODEL	T _A ≤ 25°C POWER RATING	DERATING FACTOR‡ ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
16-PIN DW	Low K	1200 mW	9.6 mW/°C	769 mW	625 mW
	High K	2240 mW	17.9 mW/°C	1434 mW	1165 mW
20-PIN DW	Low K	1483 mW	11.86 mW/°C	949 mW	771 mW
	High K	2753 mW	22 mW/°C	1762 mW	1432 mW
16-PIN N	Low K	1150 mW	9.2 mW/°C	736 mW	598 mW



SN65LBC174A, SN75LBC174A

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recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
Voltage at any bus terminal	Y, Z	−7		12	V
High-level input voltage, V _{IH}	A, EN	2		V _{CC}	V
Low-level input voltage, V _{IL}		0		0.8	
Output current		−60		60	mA
Operating free-air temperature, T _A	SN75LBC174A	0		70	°C
	SN65LBC174A	−40		85	

electrical characteristics over recommended operating conditions

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}	Input clamp voltage	$I_I = -18$ mA		-1.5	-0.77		V
V_O	Open-circuit output voltage	Y or Z, No load		0		V_{CC}	V
$ V_{OD(SS)} $	Steady-state differential output voltage magnitude [‡]	No load (open circuit)		3		V_{CC}	V
		$R_L = 54 \Omega$, See Figure 1		1	1.6	2.5	
		With common-mode loading, See Figure 2		1	1.6	2.5	
$\Delta V_{OD(SS)}$	Change in steady-state differential output voltage between logic states	See Figure 1		-0.1		0.1	V
$V_{OC(SS)}$	Steady-state common-mode output voltage	See Figure 3		2	2.4	2.8	V
$\Delta V_{OC(SS)}$	Change in steady-state common-mode output voltage between logic states	See Figure 3		-0.02		0.02	V
I_I	Input current	A, G, $\overline{G}$		-50		50	μ A
I_{OS}	Short-circuit output current		$V_I = 0$ V	-200		200	mA
			$V_I = V_{CC}$				
I_{OZ}	High-impedance-state output current	$V_{TEST} = -7$ V to 12 V, See Figure 7	EN at 0 V	-50		50	μ A
$I_{O(OFF)}$	Output current with power off		$V_{CC} = 0$ V	-10		10	
I_{CC}	Supply current	$V_I = 0$ V or V_{CC} , No load	All drivers enabled			23	mA
			All drivers disabled			1.5	

[†] All typical values are at $V_{CC} = 5$ V and 25°C.

[‡] The minimum V_{OD} may not fully comply with TIA/EIA-485-A at operating temperatures below 0°C. System designers should take the possibly of lower output signal into account in determining the maximum signal transmission distance.

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switching characteristics over recommended operating conditions

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH} Propagation delay time, low-to-high level output	$R_L = 54 \Omega$, $C_L = 50 \text{ pF}$, See Figure 4	5.5	8	11	ns
t_{PHL} Propagation delay time, high-to-low level output		5.5	8	11	ns
t_r Differential output voltage rise time		3	7.5	11	ns
t_f Differential output voltage fall time		3	7.5	11	ns
$t_{sk(p)}$ Pulse skew $ t_{PLH} - t_{PHL} $			0.6	2	ns
$t_{sk(o)}$ Output skew [†]				2	
$t_{sk(pp)}$ Part-to-part skew [‡]				3	ns
t_{PZH} Propagation delay time, high-impedance-to-high-level output	See Figure 5			25	ns
t_{PHZ} Propagation delay time, high-level-output-to-high impedance				25	ns
t_{PZL} Propagation delay time, high-impedance-to-low-level output	See Figure 6			30	ns
t_{PLZ} Propagation delay time, low-level-output-to-high impedance				20	ns

[†] Output skew ($t_{sk(o)}$) is the magnitude of the time delay difference between the outputs of a single device with all of the inputs connected together.

[‡] Part-to-part skew ($t_{sk(pp)}$) is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same input signals, the same supply voltages, at the same temperature, and have identical packages and test circuits.

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PARAMETER MEASUREMENT INFORMATION

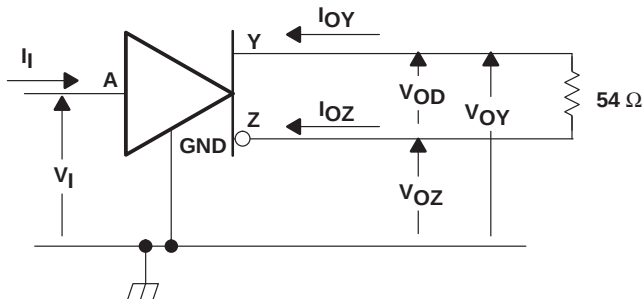


Figure 1. Test Circuit, V_{OD} Without Common-Mode Loading

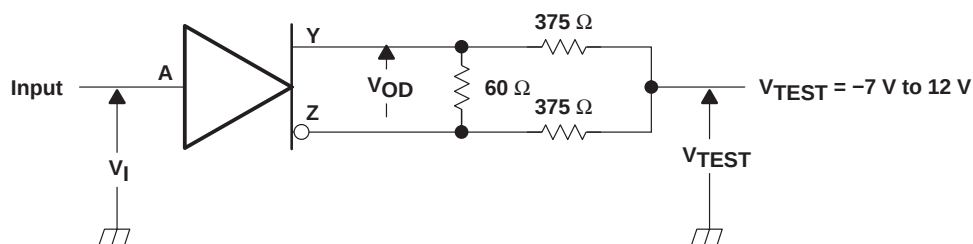
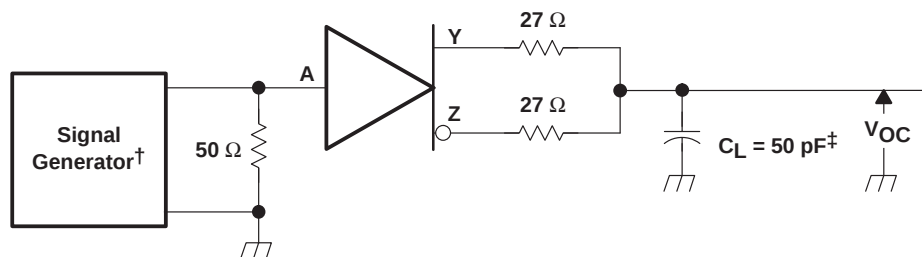


Figure 2. Test Circuit, V_{OD} With Common-Mode Loading

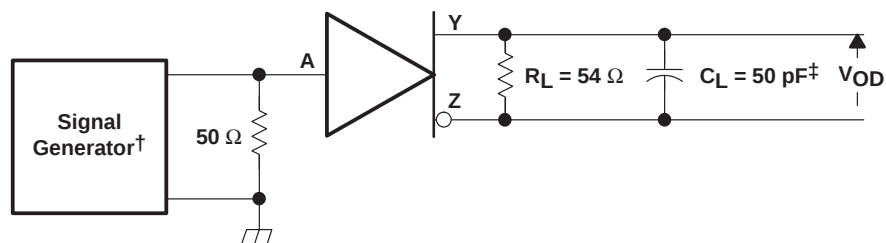


† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

Figure 3. V_{OC} Test Circuit

PARAMETER MEASUREMENT INFORMATION



† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

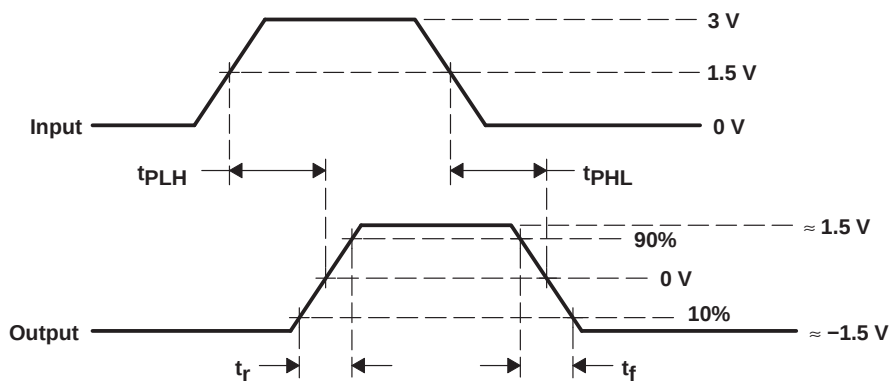
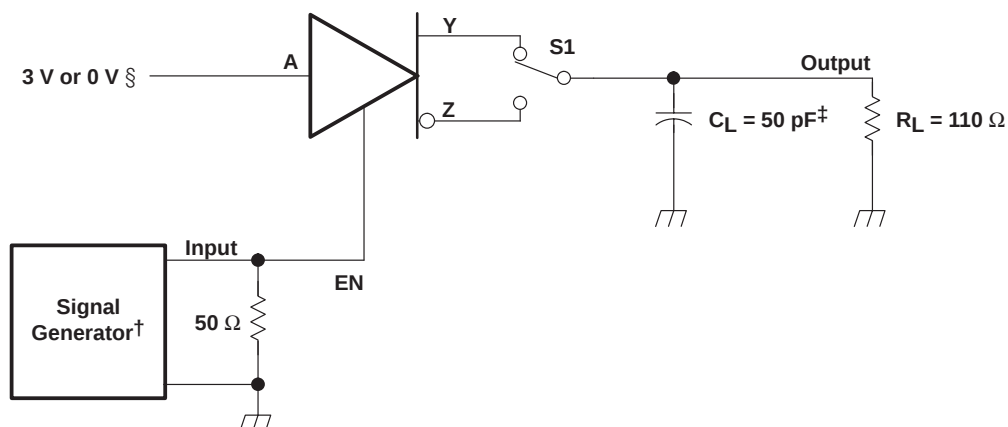


Figure 4. Output Switching Test Circuit and Waveforms

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PARAMETER MEASUREMENT INFORMATION



† PRR = 1 MHz, 50% duty cycle, $t_r < 6 \text{ ns}$, $t_f < 6 \text{ ns}$, $Z_O = 50 \text{ } \Omega$

‡ Includes probe and jig capacitance

§ 3 V if testing Y output, 0 V if testing Z output

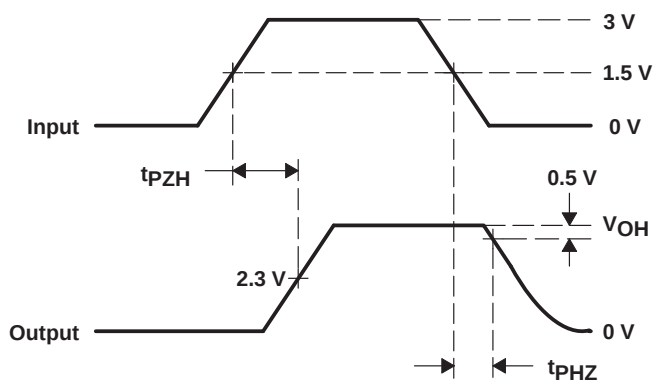
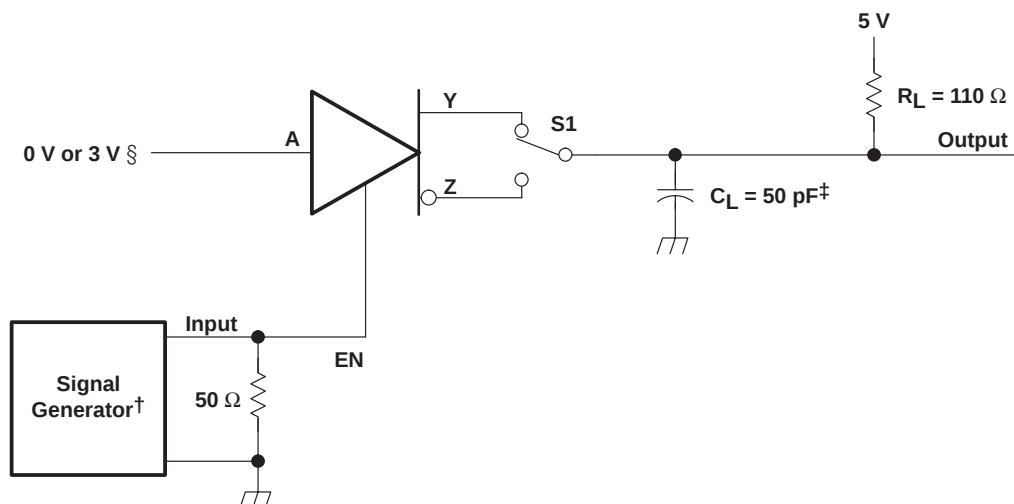


Figure 5. Enable Timing Test Circuit and Waveforms, t_{pZH} and t_{pHZ}

PARAMETER MEASUREMENT INFORMATION



† PRR = 1 MHz, 50% duty cycle, $t_r < 6$ ns, $t_f < 6$ ns, $Z_O = 50 \Omega$

‡ Includes probe and jig capacitance

§ 3 V if testing Y output, 0 V if testing Z output

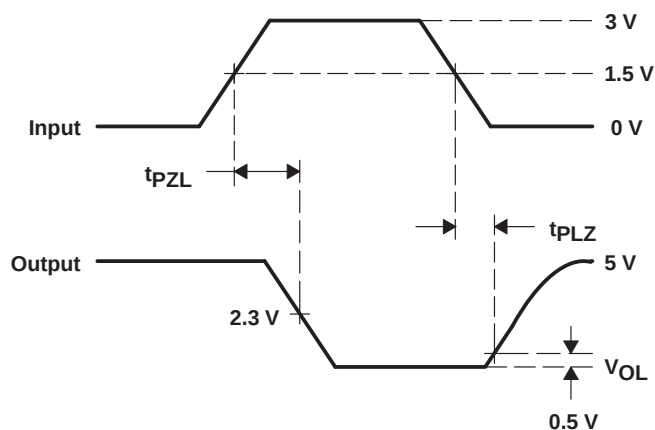


Figure 6. Enable Timing Test Circuit and Waveforms, t_{PZL} and t_{PLZ}

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PARAMETER MEASUREMENT INFORMATION

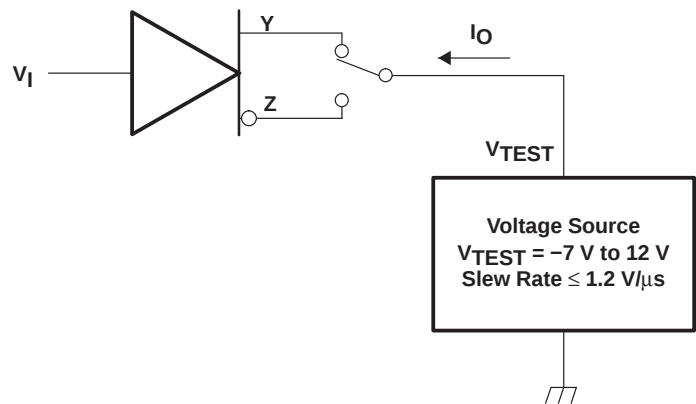


Figure 7. Test Circuit, Short-Circuit Output Current

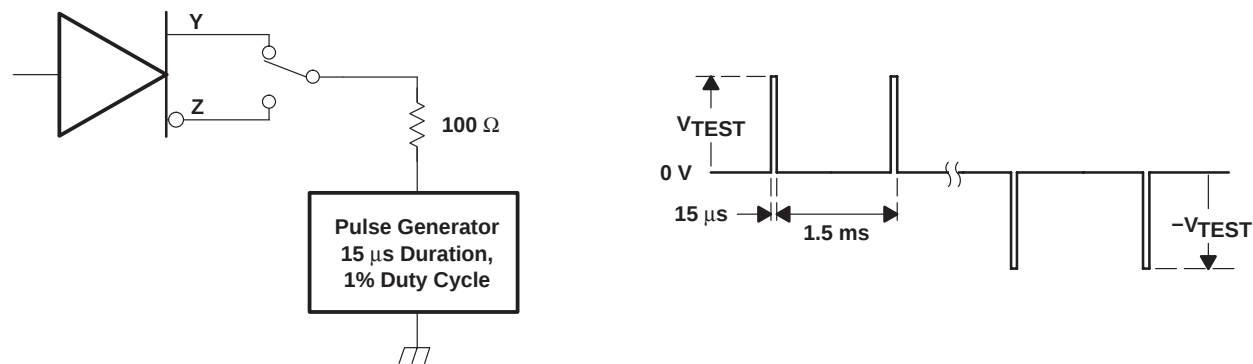
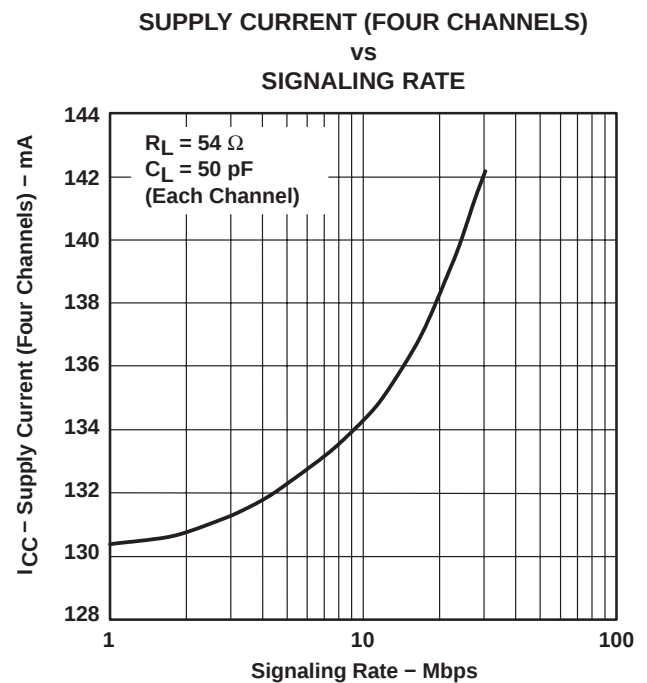
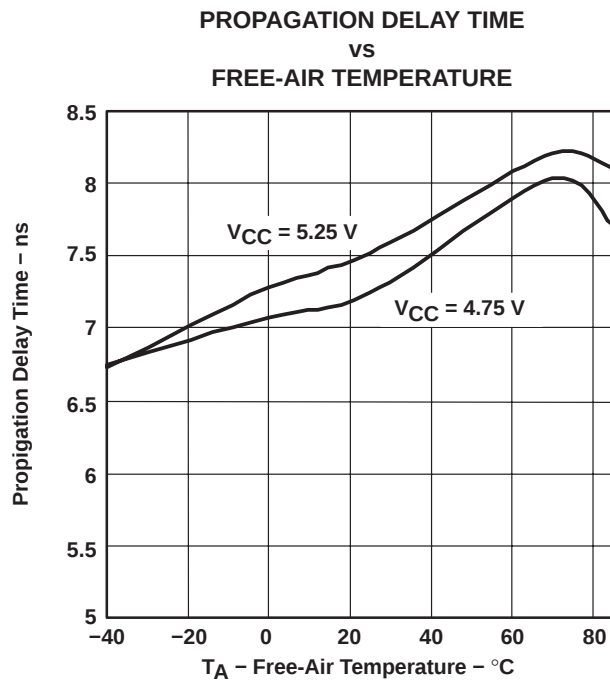
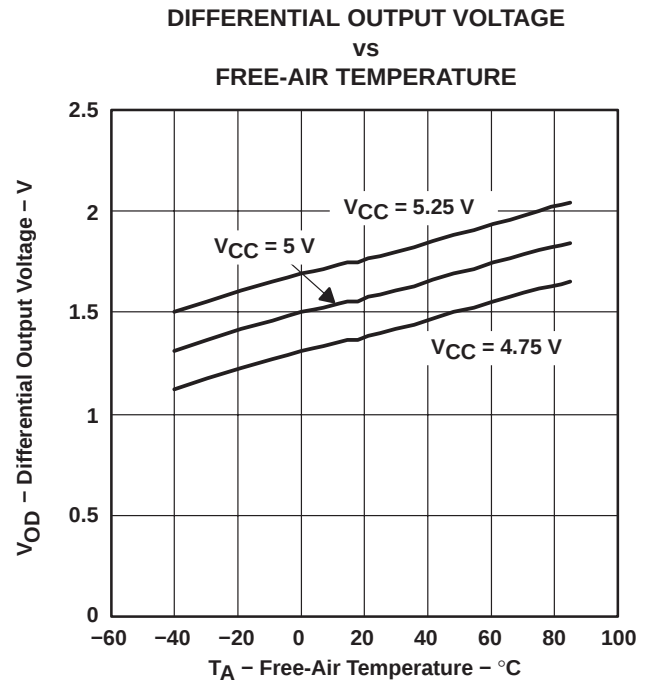
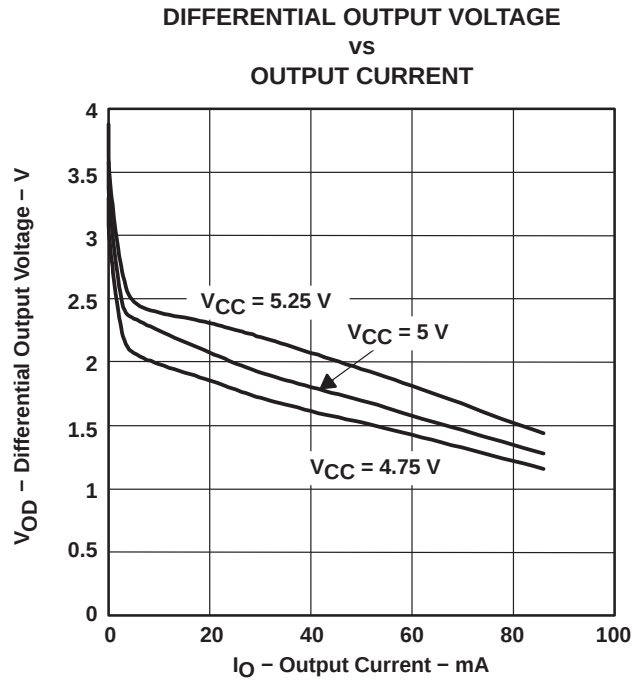


Figure 8. Test Circuit Waveform, Transient Over-Voltage Test

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TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

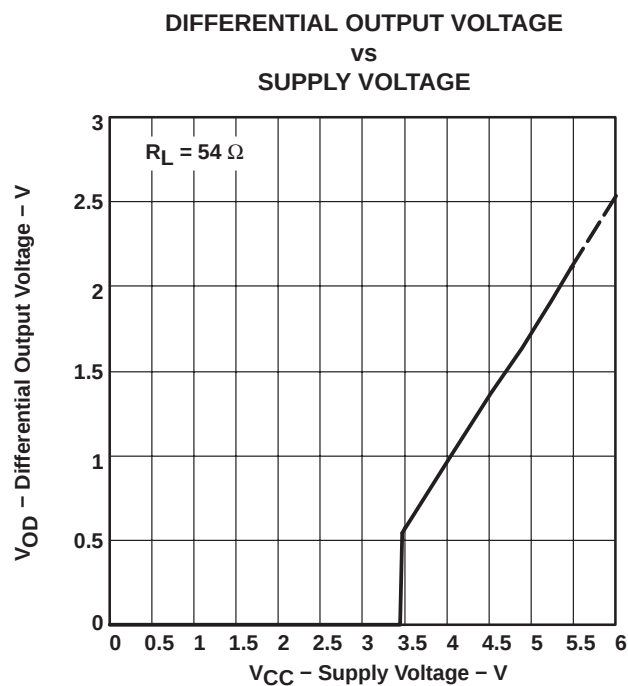


Figure 13

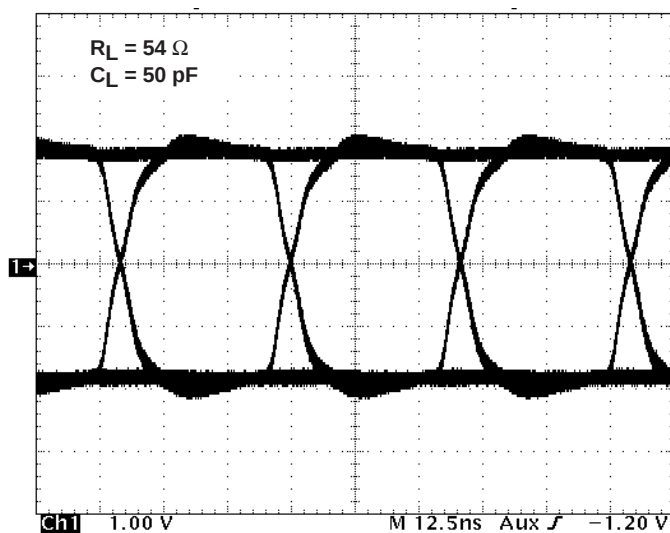


Figure 14. Eye Pattern, Pseudorandom Data at 30 Mbps

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APPLICATION INFORMATION

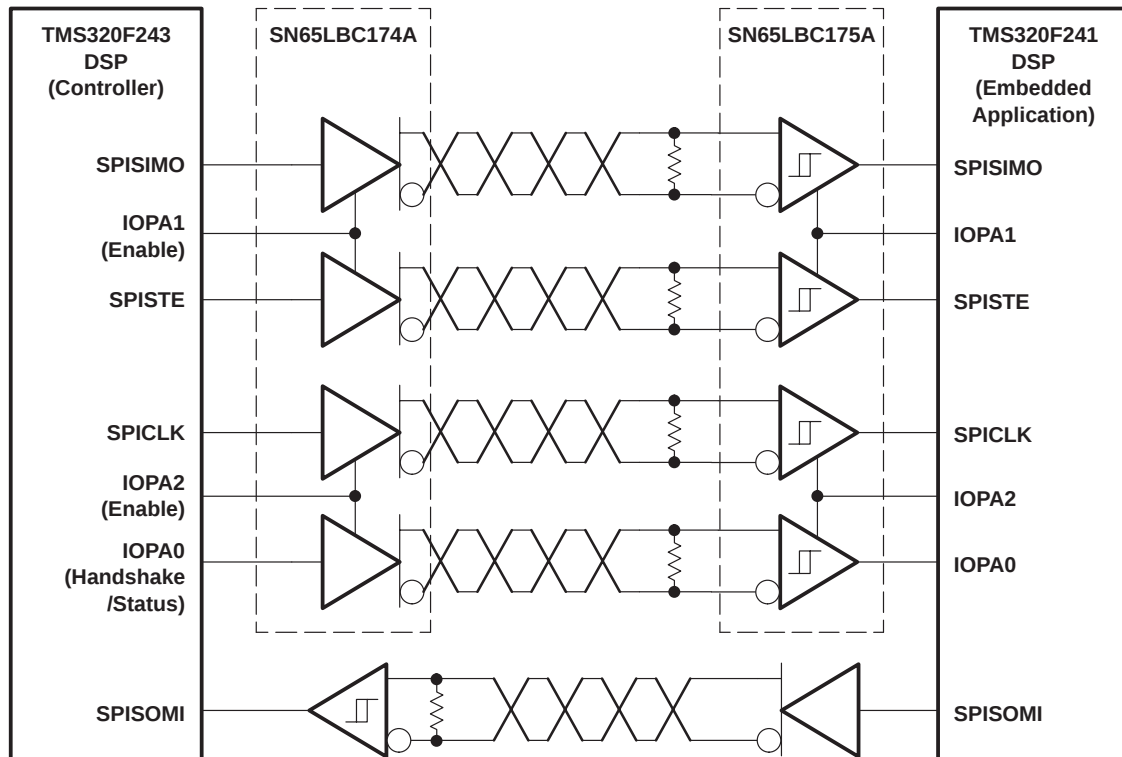


Figure 15. Typical Application Circuit, DSP-to-DSP Link via Serial Peripheral Interface

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN65LBC174A16DW	ACTIVE	SOIC	DW	16	40	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN65LBC174A16DWR	ACTIVE	SOIC	DW	16	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN65LBC174ADW	ACTIVE	SOIC	DW	20	25	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN65LBC174ADWR	ACTIVE	SOIC	DW	20	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN65LBC174AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC
SN75LBC174A16DW	ACTIVE	SOIC	DW	16	40	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN75LBC174A16DWR	ACTIVE	SOIC	DW	16	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN75LBC174ADW	ACTIVE	SOIC	DW	20	25	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN75LBC174ADWR	ACTIVE	SOIC	DW	20	2000	TBD	CU NIPDAU	Level-1-220C-UNLIM
SN75LBC174AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPD	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



PINS **	14	16	18	20
DIM				
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



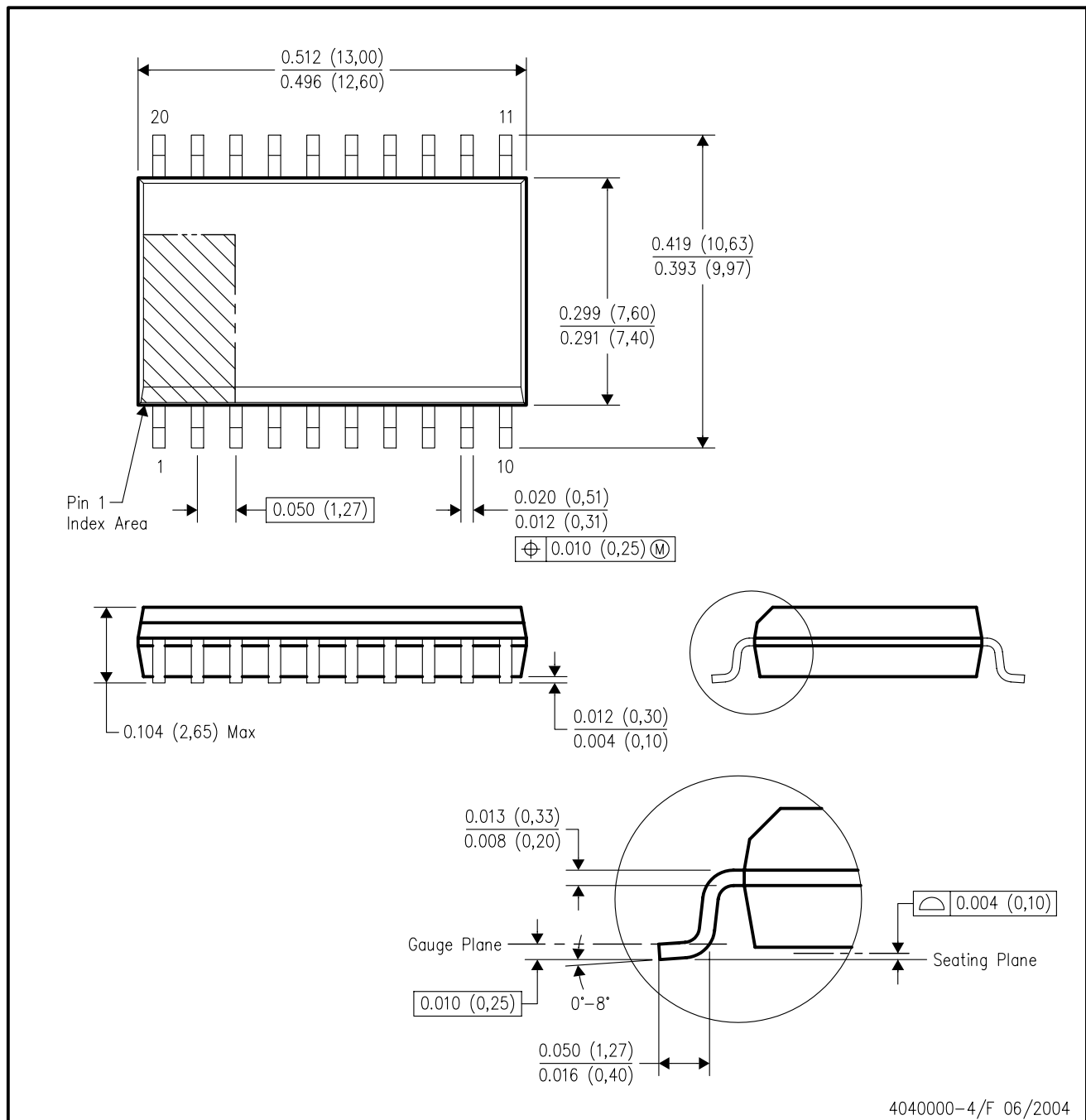
14/18 Pin Only
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G20)

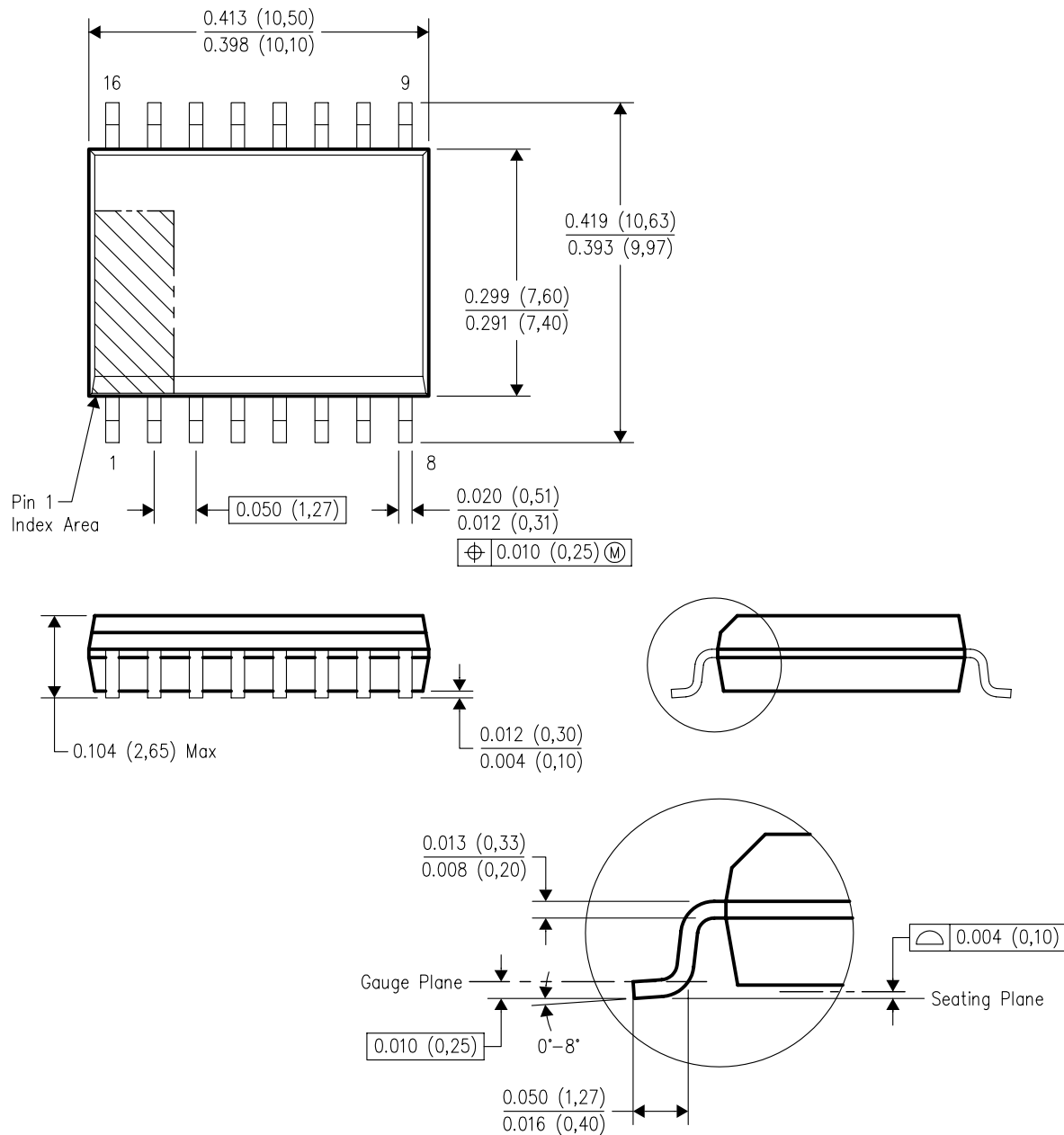
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-013 variation AC.

DW (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



4040000-2/F 06/2004

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed $0.006 (0,15)$.
 - D. Falls within JEDEC MS-013 variation AA.

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